



IXYS LLC-USA (A Littelfuse Company)
1590 Buckeye Drive
Milpitas, CA 95035

September 26, 2024

Certificate of Compliance RoHS 3

Herewith we confirm that
IXYS Devices and Chip Products
are in compliance with the requirements detailed in the
DIRECTIVE 2015/863/EU of the EUROPEAN PARLIAMENT and of the COUNCIL

With one Exception: IXYS devices currently uses a high temperature leaded solder for chip attach allowable under RoHS Annex III and IV table for Lead exemption:

7(a)	Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)
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The following items are not contained in IXYS Milpitas devices:

1. Cadmium (Cd)
2. Mercury (Hg)
3. Chromium VI (Cr+6)
4. Polybrominated Biphenyl (PBBs)
5. Polybrominated Diphenyl Ethers (PBDEs, including Deca-BDE)
6. Diisobutyl Phthalate (DIBP) CAS#84-69-5
7. Benzyl Butyl Phthalate (BBP) CAS#85-68-7
8. Bis(2-ethylhexyl) Phthalate (DEHP) CAS#117-81-7
9. Dibutyl Phthalate (DBP) CAS#84-74-2

Sonia Daley
North America Regional Quality manager